# HotChips 2009 Xeon Socket Filler FPGA Accelerators

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## Intel Xeon Accelerator Modules









## Intel Front Side Bus FPGA Accelerators

The Industry's only Xilinx Virtex-5 FSB Accelerator Module





- 64-bit 1066MHz FSB interface
- 8GB/s peak bandwidth
- 105ns host latency
- 256GB direct system memory access
- Intel MP platform compatible

- Modular product optimization for different applications
- Xilinx Virtex-5 FPGA technology
- Supported by Intel QuickAssist AAL
- C → FPGA compiler support

## **Intel QuickAssist Initiative**



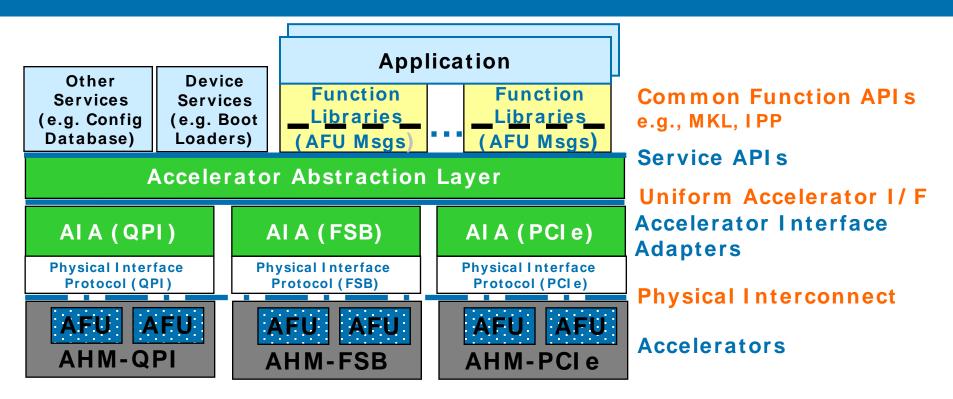
- What is Intel QuickAssist?
  - Comprehensive initiative that enables optimized use and deployment of accelerators (primarily FPGAs) on Intel platforms
- QuickAssist Accelerator Abstraction Layer (AAL)
  - Standard C/C++ API for inclusion with user application
  - Device discovery support
  - CPU initiated data transfer to FPGA (send data to accelerator)
  - CPU initiated data transfer from FPGA (receive data back from accelerator)

#### Benefits

- Common software interface supporting multiple processing technologies
- Easy migration between different technologies and form factors
- Transparent Open source approach

## Intel's Quickassist Accelerator Model





Common function library over FSB, QPI, PCIe or traditional I A based algorithms

## Integrated Development Platform

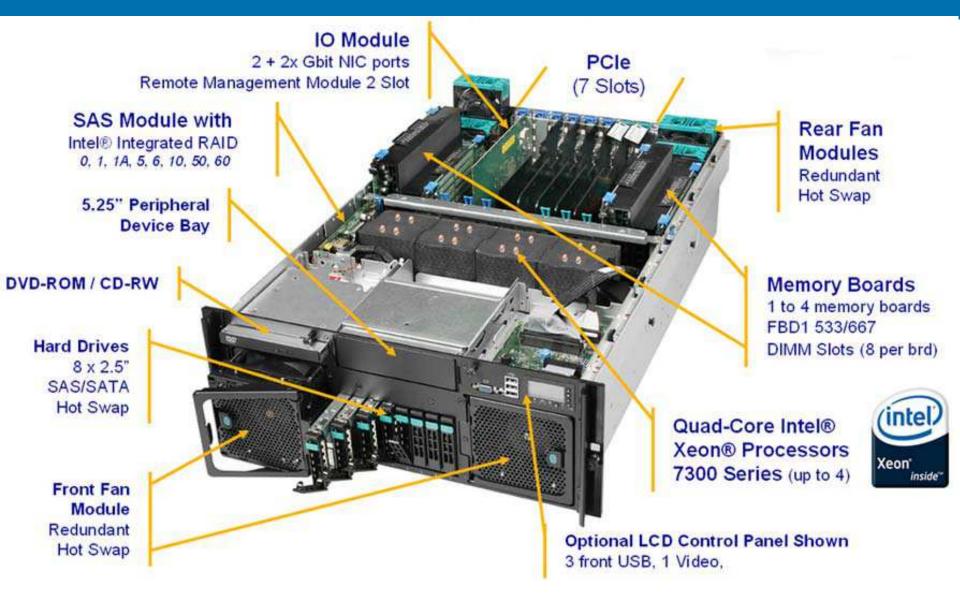


- Pre-installed FPGA hardware
- Linux operating system
- Intel QuickAssist AAL
- VHDL IP cores
- Reference designs
- Documentation
- 1 year warranty
- 1 year technical support
- Optional design service assistance



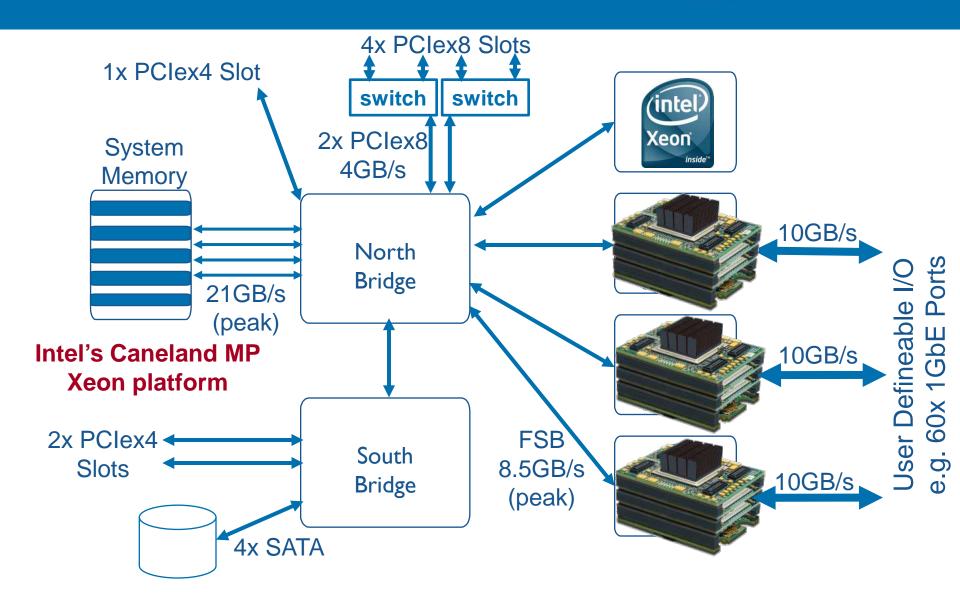
## Inside the 4U server





# **FSB Configuration Options**





## **FSB-Base Module**





- Intel Xeon mPGA604 socket
- Fits within Xeon heat sink footprint

#### Front Side Bus interface

- 64-bit 1066MHz
- 8GB/s peak bandwidth\*
- 105ns latency
- Direct access to system memory
- Encrypted FSB core

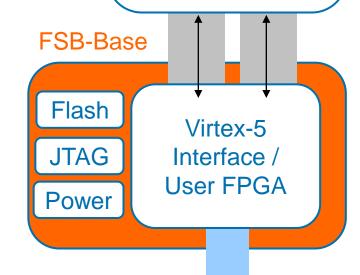
#### Virtex-5 Interface/User FPGA

- FF1738 package, 42.5mm<sup>2</sup>
- LX110-3





FSB-Compute or FSB-Expansion



64-bit/1,066MHz
Front Side Bus

<sup>\* 8</sup>GB/sec for 2 cache-line bursts

## **FSB-Compute Module**

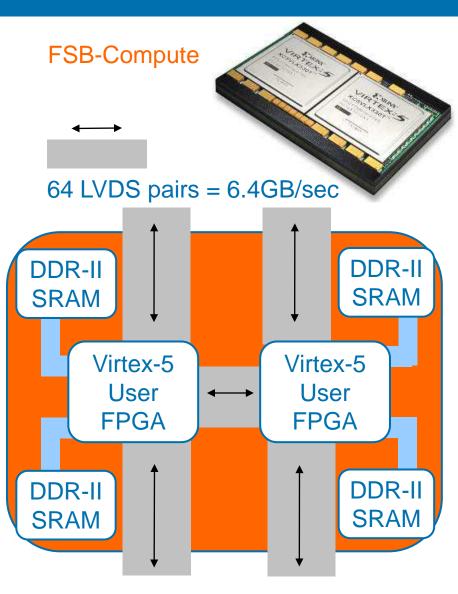


#### Virtex-5 User FPGAs

- Supports Largest LX or SX or FX FPGAs
- Up to 207,360 LUT6's
- Up to 384 DSP48's
- Up to 1032 18Kbit Block Rams

#### 4 independent banks of DDR-II SRAM

- 2 banks per FPGA
- Up to 8MBytes per bank
- 2x 32-bit data buses
- 8GB/sec total bandwidth
- Total Off Module B/W = 25.6GB/s
- Scalability
  - Ability to stack multiple FSB-Compute modules



## **FSB-Expansion Module**



#### Virtex-5 User FPGA

- Supports Largest LX or SX or FX FPGA
- >> 1TOP Fixed Precision/Bit Manipulation
- Up to 100GF Single Precision FP
- Up to 40GF Double Precision FP

#### 4 banks of QDR-II SRAM

- Up to 16 MByte per bank
- 16GB/sec total bandwidth

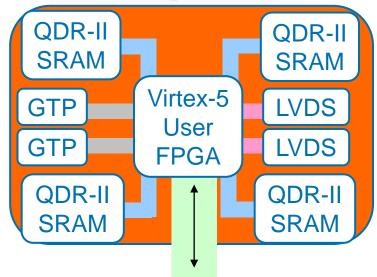
## 2 off-module GTP connectors

- 10 lanes @ 3.125Gbps per connector
- 20 lanes total = 62.5 Gbps total

## 2 off-module digital connectors

- 40 pins per connector
- Single-ended or LVDS I/O
- E.g. For High Speed Video Capture
- E.g. Ultra low latency, <20ns, point to point Comms





128 LVDS pairs = 12.8GB/sec



- Intel Xeon Server Socket
  - 73XX MP Xeon Series Compatible
  - MPGA-604 Socket
  - Zero Insertion Force Socket, ZIF





- An Interposer is required to be fitted to the ZIF Socket
  - This provides the primary mating interface for the FPGA module stack.





- FSB-BASE module plugs directly into Intel Xeon socket
- Deals with low level FSB interface
- Referred to as the "Bridge" from the host to the user logic





Heatsink fitted to FSB interface FPGA



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- ISI high density Custom Interconnect
  - 1526 pin HILO Connector
  - 0.8mm pitch
- Provides LVDS links to upper module(s)





Fits onto connectors of FSB-BASE module



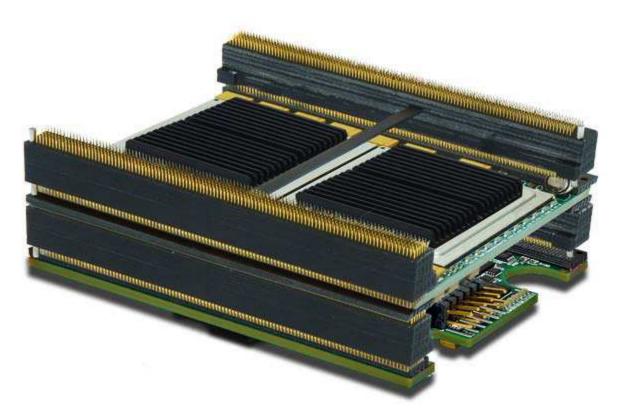


- FSB-COMPUTE module #1 mates with connector
- Heatsinks applied to user FPGAs





 Another ISI high density connector mates with FSB-COMPUTE #1 providing LVDS links to another upper module





- FSB-COMPUTE #2 mates with the connector
- Heatsinks applied to user FPGAs



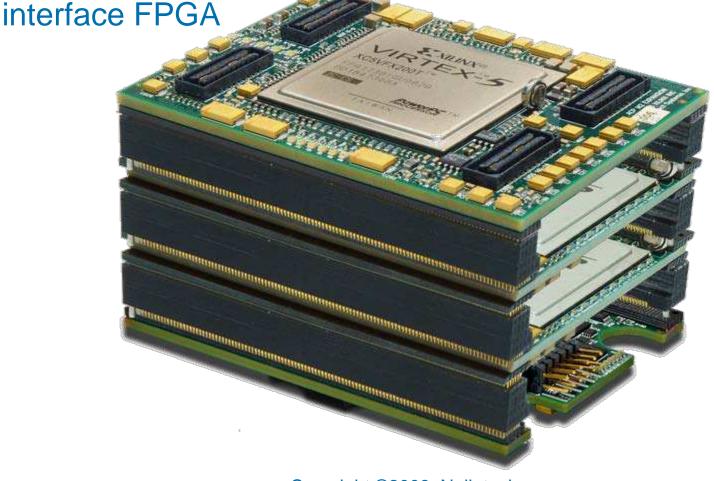


 The final ISI high density connector provides another LVDS link





The FSB-EXPANSION module mates with the connector, completing the stack of 5 Xilinx user FPGAs + FSB





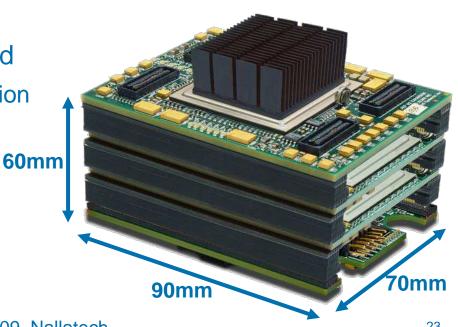
Heatsinks are fitted to user FPGA of FSB-Expansion module





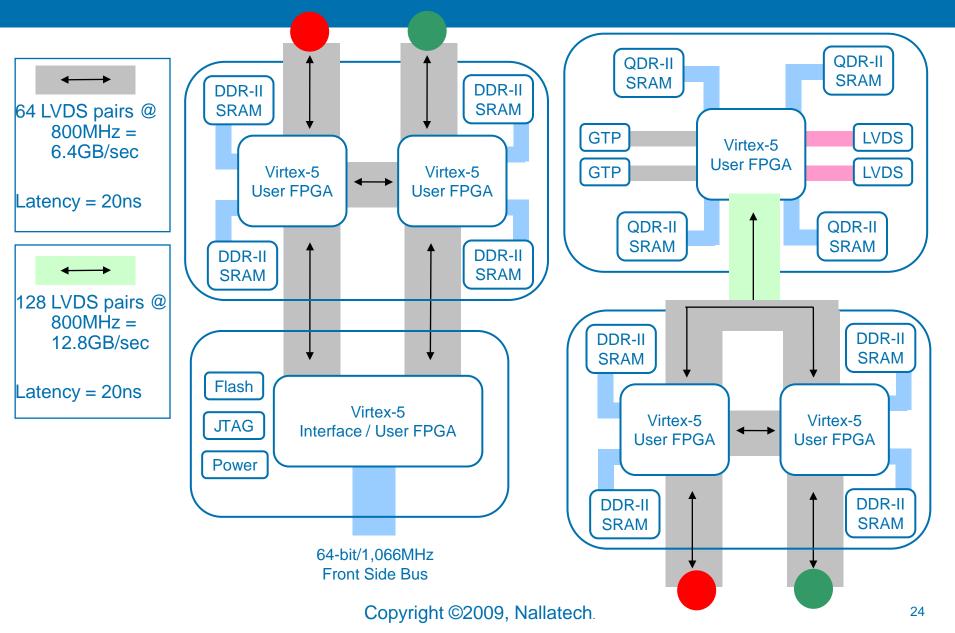
## ■ The complete stack...

- Raw Compute Performance
  - > 500GF SPFP
  - > 200GF DPFP
  - >> 5TOPs Integer / Bit Manipulation
- Power Consumption
  - Up to 130 Watts Maximum
  - 24 Watts Max per FPGA/Memory
- Stack is currently factory configured
  - Updating for Customer Configuration
    - Insertion / Extraction Tool
    - Calibration Software



# Stack Level Functional Block Diagram







# Thank You

